# October 29, 2019

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InterContinental Shanghai Pudong Hotel

# Archive

Session 4 Presentation 3

#### Planning Ahead

#### **TestConX China 2019**

# Improve Socket Performance by Simulating Embedded Device Sparameter

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Shanghai - October 29, 2019



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#### Contents

- Inductors & Inductance
- Derive Spring Pin Inductance
- Different simulation tools comparison
- Case Study Passive Device
- Improvement of socket design
- Discussion & Future Plan



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#### **Inductors & Inductance**

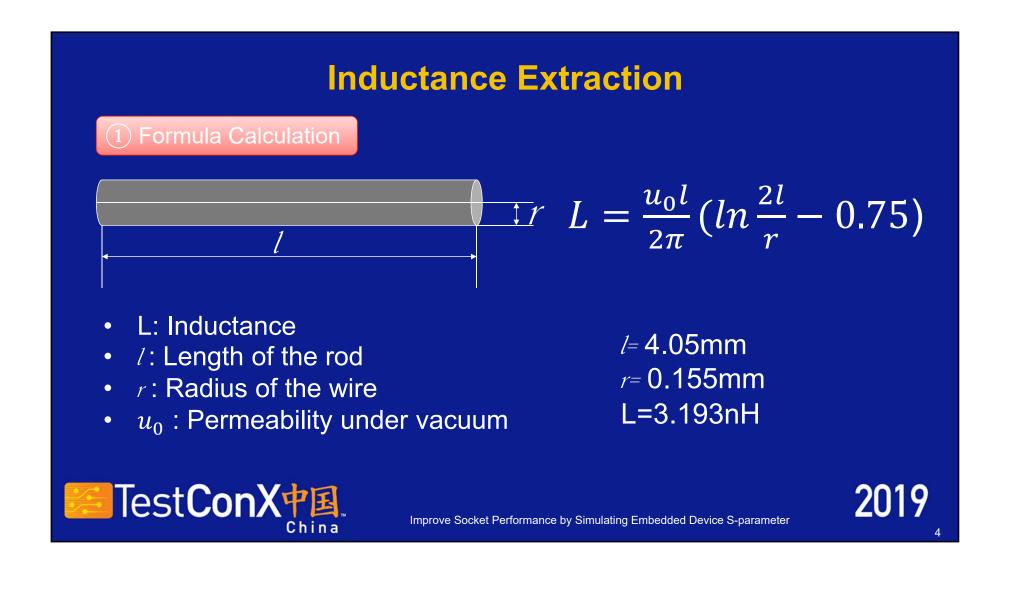
- Inductance is a critically important electrical property because it affects all four of the fundamental signal integrity problems.
- In many case, the goal will be to decrease inductance
  - Mutual inductance / Switching noise
  - Loop inductance / Power distribution network
  - Effective inductance of return plans / EMI
- Inductance is a physical quantity to measure the ability of coil to produce electromagnetic induction
- $L = \frac{\varphi}{I}$



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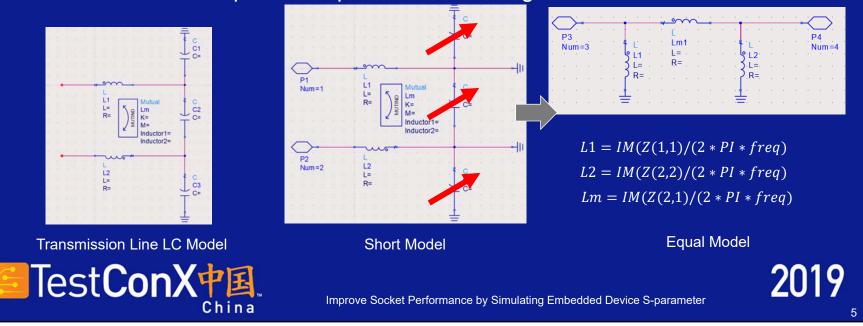


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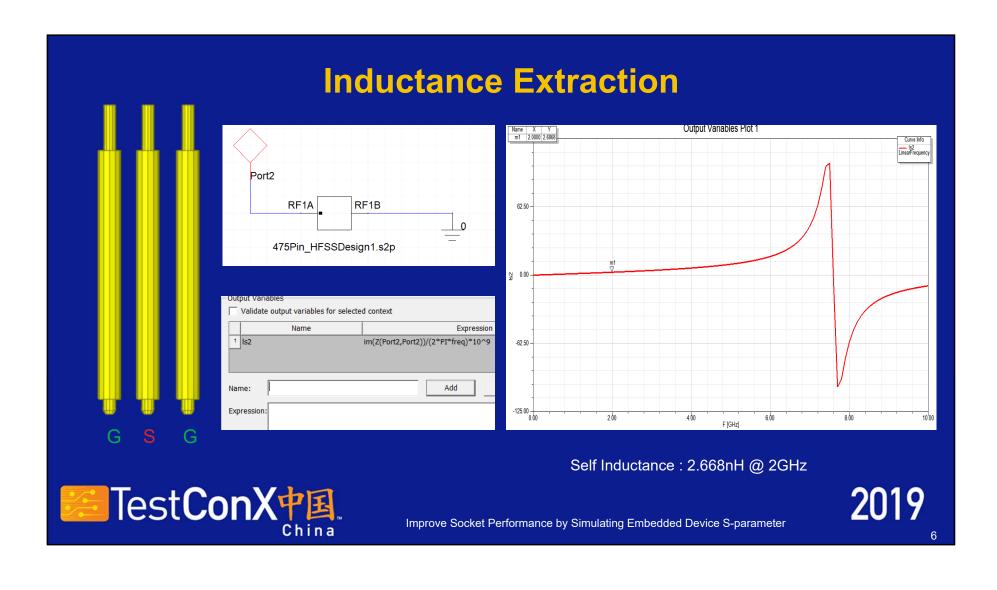
#### **Inductance Extraction**

#### 2 Full Wave Solver + Circuit Analysis

• It is often need to do inductance and capacitance components to complete circuit design during chip design, so it is important to evaluate the value of inductance and capacitance prior to circuit design.

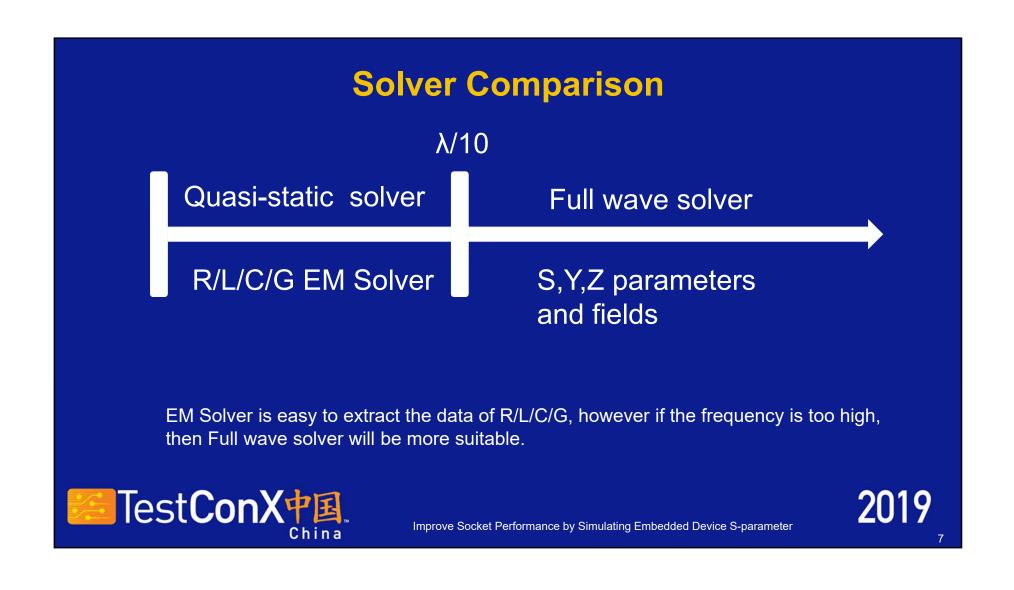


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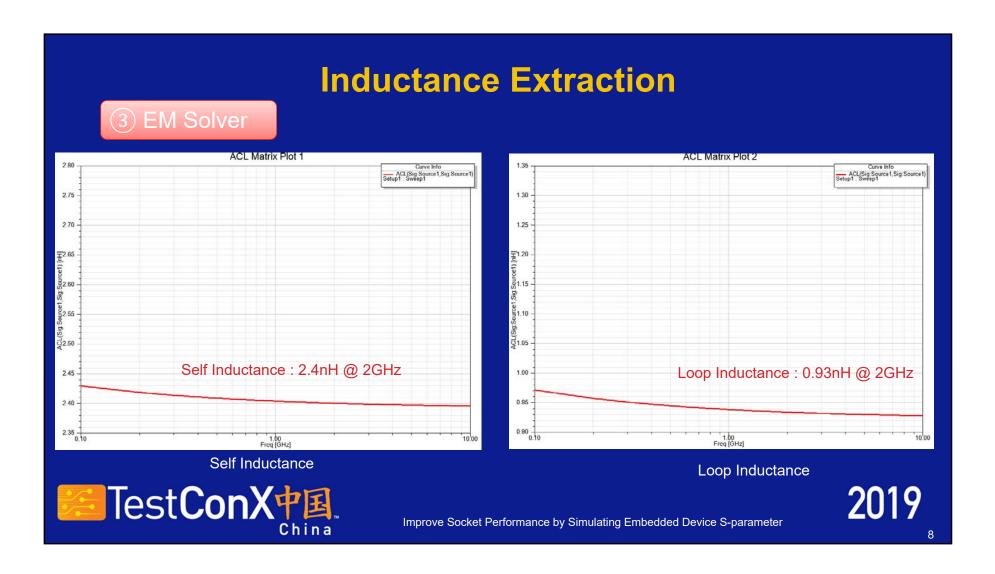


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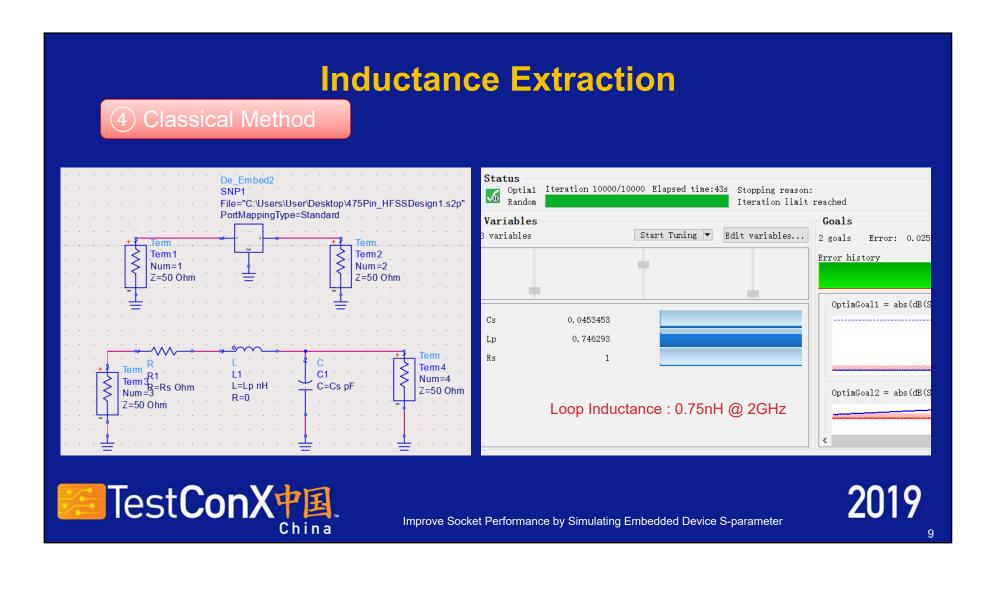


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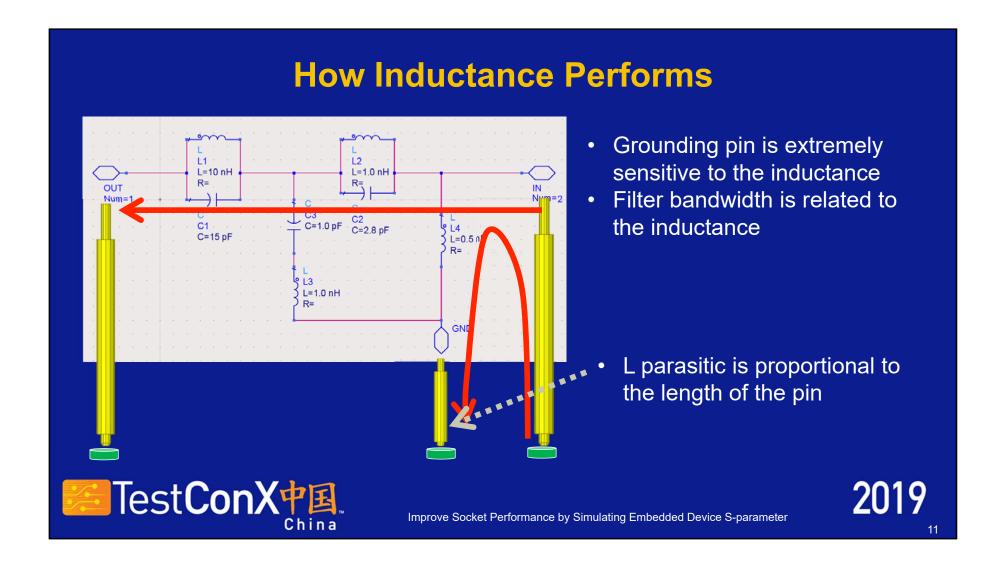
1Formula calculation3.193nH2Full Wave Solver2.668nH	Data Summary				
2 Full Wave Solver 2.668nH	ltem	Theory	Self	Loop	
	1	Formula calculation	3.193nH		
3 EM Solver 2.4nH 0.94nH	2	Full Wave Solver	2.668nH		
	3	EM Solver	2.4nH	0.94nH	
4 Classical Optimization 0.75nH	4	<b>Classical Optimization</b>		0.75nH	



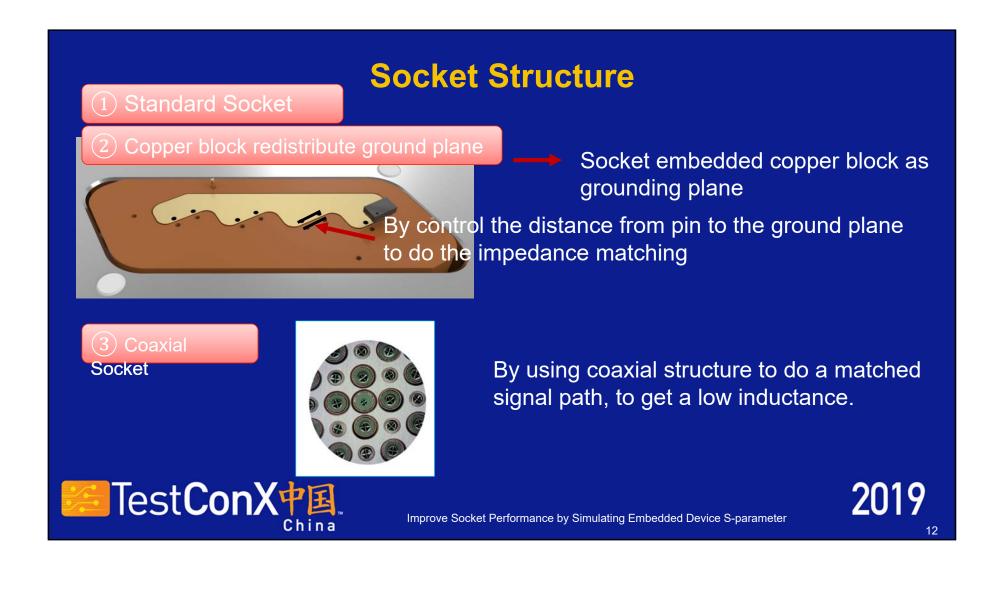
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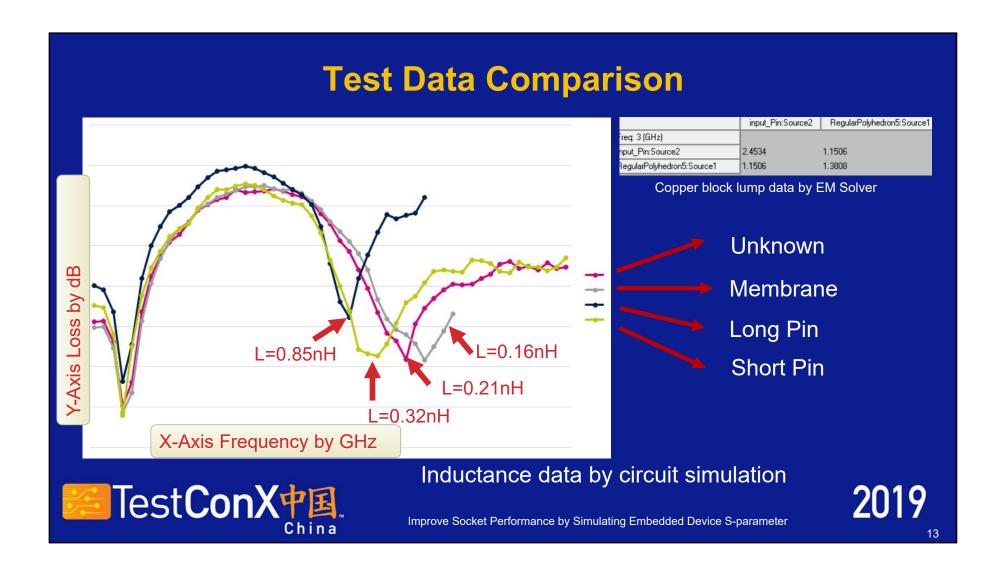
**Planning Ahead** 



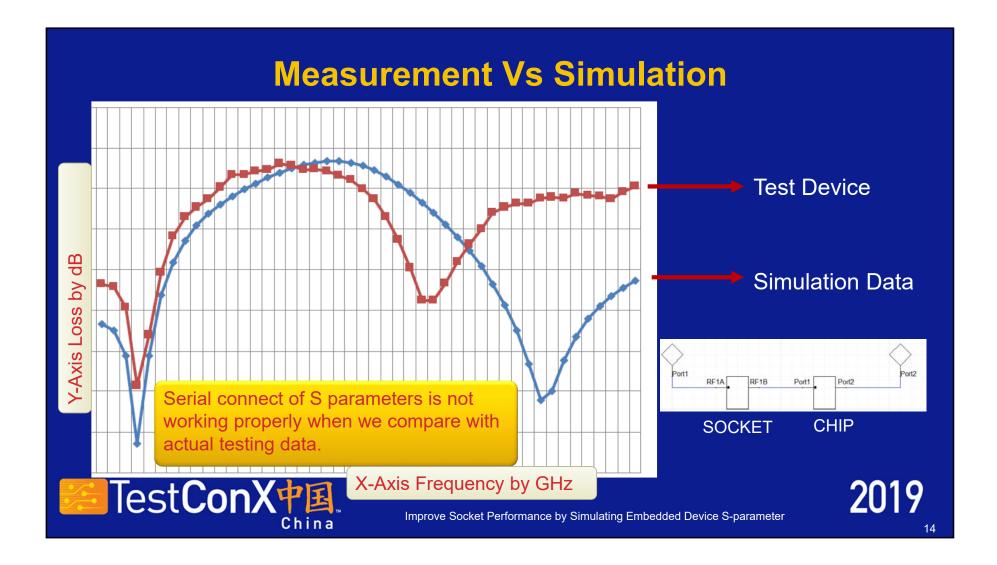
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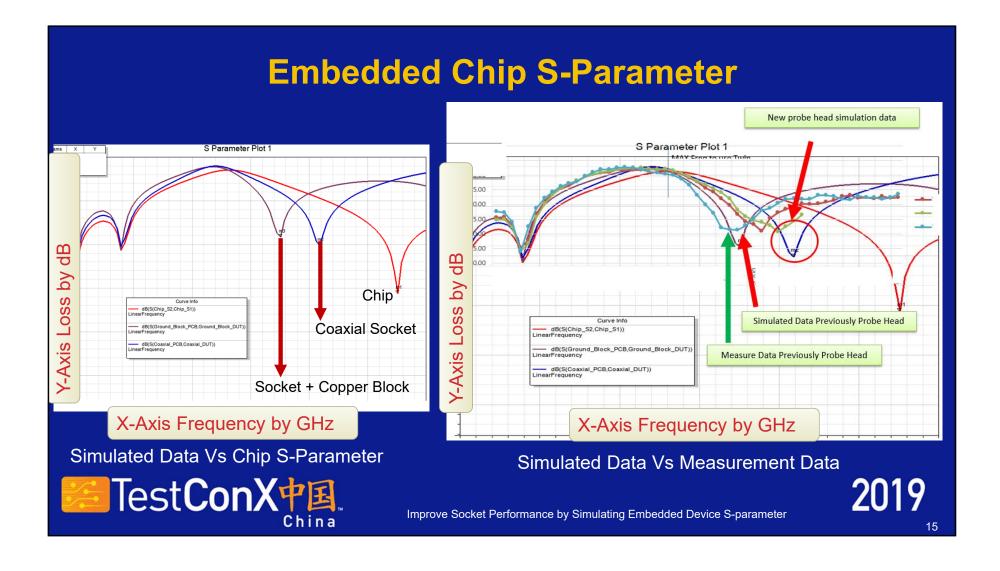
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#### **Summary & Discussion**

- Passive circuitry is more sensitive to the inductance which introduce by the spring pin.
- EM solver is more convenient and easy to get the inductance data of spring pin.
- Embedded the Chip of S-Parameter is more close the actual measurement data, and help for improvement of socket design.



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